

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of: )  
 Estuko FUJIMOTO et al )  
 Serial No.: Not Assigned )  
 Filed: Herewith )  
 Examiner: )  
 Art Unit: )  
 For: SEMICONDUCTOR DEVICE AND METHOD )  
 OF MANUFACTURING THE SAME )

#2 IDS  
 5/2/02  
 "Express Mail" Mailing Label No. EL 845499574

Date of Deposit October 24, 2001

I hereby certify that this correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to: Commissioner for Patents, Washington, D.C. 20231

Name Yue X. Ruan  
 (typed or printed)

Signature Yue X. Ruan

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents  
 Washington, D.C. 20231

Dear Sir:

Pursuant to 37 C.F.R. §1.97, as revised on February 4, 1992, 1135 OG 23-24, Applicant hereby calls the Examiner's attention to documents listed on the attached form, which documents may be material to the examination of this application. Copies of the references are enclosed herewith for the Examiner's consideration.

No inference should be drawn that any apparatus disclosed is equivalent to the subject invention.

The citation of the above-discussed documents is not to be construed as an assertion that more pertinent art could not possibly be in existence. Citation of any document herein is not to be construed as an admission that any subject matter disclosed in the document is necessarily within the inventive field of endeavor, that any disclosure is necessarily prior in time to a particular date which may be relevant to the instant patent

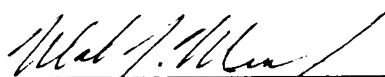
JC979 U.S. PRO  
 10/017114  
 10/24/01

application, and/or that any disclosure is otherwise necessarily prior art with respect to the instant invention.

Applicant also respectfully reserves the right to later set forth how the instant invention is distinguished over the disclosure of any document or other art, including the disclosure of those documents discussed herein, that may be cited by the Examiner in rejecting a claim in the instant patent application.

A first office action, notice of allowance or issue fee notification has not been received in this case, so Applicant does not believe that a fee is due. However, if any such fee is required, please charge our Deposit Account No. 50/1039.

Respectfully submitted,



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Mark J. Murphy  
Registration No.: 34,225

COOK, ALEX, McFARRON, MANZO  
CUMMINGS & MEHLER, LTD.  
200 West Adams Street, Suite 2850  
Chicago, Illinois 60606  
(312) 236-8500

LIST OF PUBLICATIONS  
CITED BY APPLICANT

Attorney Docket No.  
SEL 283

Serial No.  
Not Assigned

Applicant  
Estuko FUJIMOTO et al

Filing Date  
Herewith

Group

10/01/14  
10/24/01

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
	JP 05-075033 -	03/26/93	Hitachi, Ltd.			09/12/91
	JP 06-196494 -	07/15/94	Kawasaki Steel Corp.			12/22/92
	JP 07-142734 -	06/02/95	Gold Star Electronics			05/17/94
	JP 2000- 208778 -	07/28/00	Semiconductor Energy Lab			11/10/99
	JP 2000- 216396 -	08/04/00	Semiconductor Energy Lab			11/09/99
	JP 2000- 216398 -	08/04/00	Semiconductor Energy Lab			11/16/99
	JP 2000- 223716 -	08/11/00	Semiconductor Energy Lab			11/25/99
	JP 2000- 228527 -	08/15/00	Semiconductor Energy Lab			12/03/99
	JP 2000- 236097 -	08/29/00	Semiconductor Energy Lab			12/17/99
	JP 2000- 243975	09/08/00	Semiconductor Energy Lab			12/24/99
	JP 2001- 094113	04/06/01	Semiconductor Energy Lab			11/17/99
	JP 2001- 094116	04/06/01	Semiconductor Energy Lab			07/21/00
	JP 2001- 111060	04/20/01	Semiconductor Energy Lab			07/21/00
	JP 2001- 210832	08/03/01	Semiconductor Energy Lab			11/14/00

OTHER PUBLICATIONS  
(Including Author, Title, Date, Pertinent Pages)

- 1) U.S. Patent Application No. 09/433,705 (pending) including specification, claims, abstract and drawings.
- 2) U.S. Patent Application No. 09/436,984 (pending) including specification, claims, abstract and drawings.
- 3) U.S. Patent Application No. 09/447,574 (pending) including specification, claims, abstract and drawings.
- 4) U.S. Patent Application No. 09/464,200 (pending) including specification, claims, abstract and drawings.
- 5) U.S. Patent Application No. 09/471,359 (pending) including specification, claims, abstract and drawings.
- 6) U.S. Patent Application No. 09/714,891 (pending) including specification, claims, abstract and drawings.
- 7) U.S. Patent Application No. 09/432,662 (pending) including specification, claims, abstract and drawings.
- 8) U.S. Patent Application No. 09/435,154 (pending) including specification, claims, abstract and drawings.
- 9) U.S. Patent Application No. 09/441,025 (pending) including specification, claims, abstract and drawings.
- 10) U.S. Patent Application No. 09/454,146 (pending) including specification, claims, abstract and drawings.
- 11) U.S. Patent Application No. 09/618,930 (pending) including specification, claims, abstract and drawings.
- 12) U.S. Patent Application No. 09/619,732 (pending) including specification, claims, abstract and drawings.
- 13) English abstract re Japanese Patent Application No. JP 05-075033.
- 14) English abstract re Japanese Patent Application No. JP 06-196494.
- 15) English abstract re Japanese Patent Application No. JP 07-142734.
- 16) English abstract re Japanese Patent Application No. JP 2000-208778.
- 17) English abstract re Japanese Patent Application No. JP 2000-216396.
- 18) English abstract re Japanese Patent Application No. JP 2000-216398.
- 19) English abstract re Japanese Patent Application No. JP 2000-223716.
- 20) English abstract re Japanese Patent Application No. JP 2000-228527.
- 21) English abstract re Japanese Patent Application No. JP 2000-236097.
- 22) English abstract re Japanese Patent Application No. JP 2000-243975.
- 23) English abstract re Japanese Patent Application No. JP 2001-094113.
- 24) English abstract re Japanese Patent Application No. JP 2001-094116.
- 25) English abstract re Japanese Patent Application No. JP 2001-111060.
- 26) English abstract re Japanese Patent Application No. JP 2001-210832.

EXAMINER:

DATE CONSIDERED:

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.